



Measuring Temperature Using the Watch Dog Timer (WDT)

*Author: Ian Lao
Microchip Technology Inc.
Chandler, AZ*

INTRODUCTION

This application note shows how Microchip Technology's Watch Dog Timer (WDT) can be used to acquire rough temperature measurements.

Recent advances in sensor technology have allowed for the development of many different sensors to measure temperature. However, almost all of these are implemented as dedicated function sensors.

Microchip has now developed a method of combining both rough temperature sensing and microcontroller functionality on the same device without the need for external components.

Preliminary analysis of the on-board WDT shows a piecewise linear correlation between temperature and the timeout period of the WDT. The WDT timeout period appears to increase for a fixed VDD as temperature increases. Tests indicate that this property may be used for cost effective rough temperature sensing.

The WDT module is similar across many families of microcontrollers from Microchip. This allows for a wide range of different applications to be developed using the same technique.

Though actual application results may differ, an accuracy of up to $\pm 1^\circ\text{C}$ may be seen. The linearity of the WDT is not guaranteed but has been observed.

Note: It is up to the user to test the device in the system to determine accuracy/usability.

THEORY

The WDT is an 8-bit timer with an 8-bit pre-scaler option driven from a free running on-chip RC oscillator. This oscillator is completely independent of pins OSC1/CLKIN, OSC2/CLKOUT, and the INTRC oscillator. As with any RC oscillator, variances in temperature will affect the frequency of the circuit. Cumulative effects will therefore show up as a change in the timeout period of the WDT.

By utilizing another timer as a reference, a sample may be established whereby changes in the WDT timeout period can be measured. Calibrated temperature can then be derived via Equation 1.

Equation 1:

$$CC = \text{COUNT} * \text{Scalar} - \text{Offset}$$

CC => calibrated count value

C => COUNT; number of times TMR0 has rolled over
Offset => calibration offset due to voltage variance or self-heating (determined by testing against a known fixed temperature)

Scalar => calibration scalar due to process or application design ("slope" determined by testing 2 known temperatures)

Process variations across lots, part families, and different cores are expected. Since the WDT is clocked by an RC oscillator, these differences are expected to influence the "slope" of the piecewise linear WDT response.

HARDWARE REQUIRED

1. Voltage/temperature regulated power supply
2. Temperature-compensated oscillator or crystal clock source

Note: If the INTRC is used for the reference timer, no external clock components are required to implement this design. For greater accuracy, an external temperature-compensated oscillator may be used.

IMPLEMENTATION

Resources Used

This design uses two timers and a 16-bit count register to count the number of times TMR0 has rolled over since the last WDT timeout. Two calibration constants are used to negate the effects of self-heating and process variation/application design.

1. Reference Timer (TMR0);
The reference timer may be implemented using the INTRC or an external temperature-compensated clock source to drive TMR0.
2. Measurement Timer (WDT);
The WDT is utilized as the measurement timer. It is configured to use the on-board prescaler that is set to a ratio of 1:8 in this example. A ratio of 1:8 was chosen to allow the 16-bit count register to capture usable TMR0 roll overs without overflowing. This ratio also allows for a granularity in the count register small enough to detect changes in temperature.

Note: Users should test their code to determine the appropriate prescaler ratio to use in their application.

Firmware

Once TMR0 and WDT are configured, both are released to begin incrementing. A 16-bit register is used to count the number of times TMR0 rolls over (COUNT). TMR0 is allowed to continue incrementing and rolling over until the WDT times out. This COUNT is then used as the input to Equation 1 to give a resultant calibrated count.

Use caution when interrupts other than TMR0 (for devices that have interrupts), are active during rough temperature measurements to ensure capturing all TMR0 roll over events. WDT timeouts are asynchronous events. Missing a TMR0 rollover will add to the error of the reading.

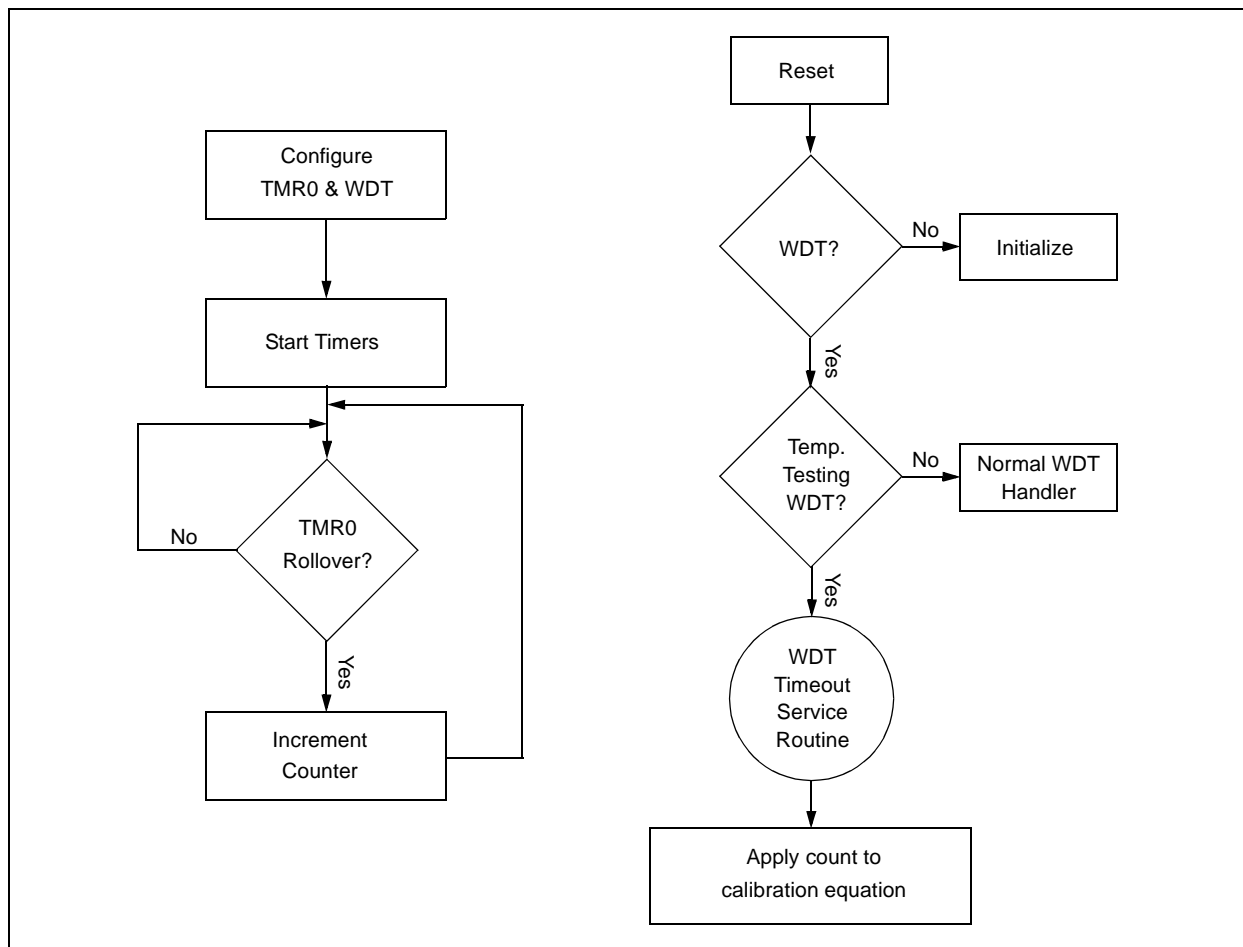
A look-up table or algorithm may be used to convert the calibrated count to Fahrenheit or Celsius for display.

Figure 1 illustrates the flow diagram for this program.

Appendix A is the source code listing.

Note: The part must not be put into sleep mode during temperature measurements as sleep mode disables TMR0.

FIGURE 1: FIRMWARE FLOW DIAGRAM



CALIBRATION

In using the WDT to measure temperature, calibration of the microcontroller against system errors is required. Since the WDT is piece-wise linear with temperature, we know that the two major components of error are the Scalar (Slope) of the line and the "offset" of the line. Process variations in the RC oscillator, which clocks the WDT and the application design itself, will determine Scalar. Variations in operating voltage and self-heating cause "offset".

In order to calibrate a part to measure temperature, both of these co-efficients must be determined and stored in memory for future use. Two dedicated memory locations (normally near the end of memory) are used to store them. Users should write their application program to include a calibration mode that uses the WDT temperature measurement mechanism, but outputs the uncalibrated count values onto the port pins. This program is then run against two known calibration temperatures. The difference in count values divided by the difference in known temperatures is the Scalar. By assigning a calibrated COUNT value to one of the two known calibration temperatures and solving Equation 1, the "offset" can be determined. In-Circuit Serial Programming™ (ICSP) mode or Serial EEPROM can then be used to store the two calibration values.

All of the sources of error mentioned in Section should also be taken into consideration when calibrating.

EXAMPLE 1:

Calibration example assuming:

1. Fixed temperature-compensated VDD
2. Fixed temperature-compensated reference oscillator
3. Area of temperature interest: +25°C - +75°C
4. Measured uncalibrated COUNTS @ +25°C
Calibration Point 1: COUNT = 475 decimal
5. Measured uncalibrated COUNTS @ +75°C
Calibration Point 2: COUNT = 595 decimal

To calculate the Scalar (Slope), the formula is:

$$\text{Scalar} = \frac{\text{Cal Point 2} - \text{Cal Point 1}}{\text{Temp Cal Point 2} - \text{Temp Cal Point 1}}$$

$$\text{Scalar} = \frac{595 - 475}{+75^{\circ}\text{C} - +25^{\circ}\text{C}} = 2.4 \text{ COUNT}/^{\circ}\text{C}$$

$$\text{Scaler} = 2.4 \text{ COUNT}/^{\circ}\text{C}$$

To calculate the offset, the formula is:

$$\text{Assigned Cal. COUNT Value} = \text{COUNT} \times \text{Scalar} - \text{Offset}$$

$$\text{Assume Assigned Value} = 0$$

$$0 = \text{COUNT} \times \text{Scalar} - \text{Offset}$$

$$\text{Offset} = \text{COUNT} \times \text{Scalar}$$

$$\text{@ } +25^{\circ}\text{C Offset} = \text{Uncal. COUNT} \times \text{Scalar}$$

$$1140.0 = 475 \times 2.4$$

$$\text{Now Scalar} = 2.4 \text{ and Offset} = 1140.0$$

EXAMPLE 2:

To make a calibrated COUNT calculation @ 55°C:

$$\text{CC} = \text{COUNT} \times \text{Scalar} - \text{Offset}$$

$$\text{@ } +55^{\circ}\text{C } 192 = 555.0 \times 2.4 - 1140.0$$

SOURCES OF ERROR

When taking temperature measurements, errors may be introduced into the calculations. The most common sources of errors are:

1. Insufficient soak time;
A certain amount of time is required for any system to stabilize. The varying materials used typically require time to reach thermal equilibrium.
2. Insufficient acquisition time;
Total acquisition time is typically represented by the equation:
$$T_{\text{Aq}} = T_{\text{Soak}} + T_{\text{Sample}}$$

 T_{Aq} => acquisition time. Total time to make a calibrated measurement.
 T_{Soak} => soak time to reach thermal equilibrium
 T_{Sample} => time required to capture a number of uncalibrated COUNTS and average the result of the raw data through a "debounce" algorithm
3. Calibration errors;
Errors may be introduced by incorrectly determining the Scalar or Offset values. Both of these equation terms are based on controlled known temperatures.
4. Sample error;
Since temperature does not change quickly (i.e., in the milliseconds), typical applications will apply an algorithm similar to "debounce" that will filter out momentary spikes and steps in temperature readings.
5. Power supply;
Variances in power supply voltage will effect the INTRC, external oscillator and WDT RC oscillator. These affects may be self-canceling in your application.
6. Reference oscillator;
Variances in the reference oscillator due to process, voltage or temperature will affect TMRO.

COMMON USES

Many designs typically use rough temperature data as trip points to indicate over-heating or operation below recommended minimum temperature specifications. Other uses may include but are not limited to:

1. Rough calibration of other hardware/systems/ processes
2. Temperature hysteresis measurements

EXPERIMENTAL DATA

The data in Figure 2 was collected using a sample of 8 typical production PIC12C509A parts from the same manufacturing lot. A test board containing all eight parts was then given a soak time of thirty minutes at each tested temperature. Five hundred uncalibrated raw data COUNTS were then recorded and averaged for each tested temperature to produce Figure 2.

- Voltage was supplied and measured via a Topward 3303D DC power supply and Fluke model 87 DMM, respectively.
- A Hart Scientific High Precision Bath Model 7025 with Hart Scientific Black Stack Temperature Probe model 2560 provided the various different temperatures.
- Data was captured using Hyperterminal running on a Windows 95 configured PC.

FIGURE 2: UNCALIBRATED COUNT DATA (V_{DD} = 5.0V)

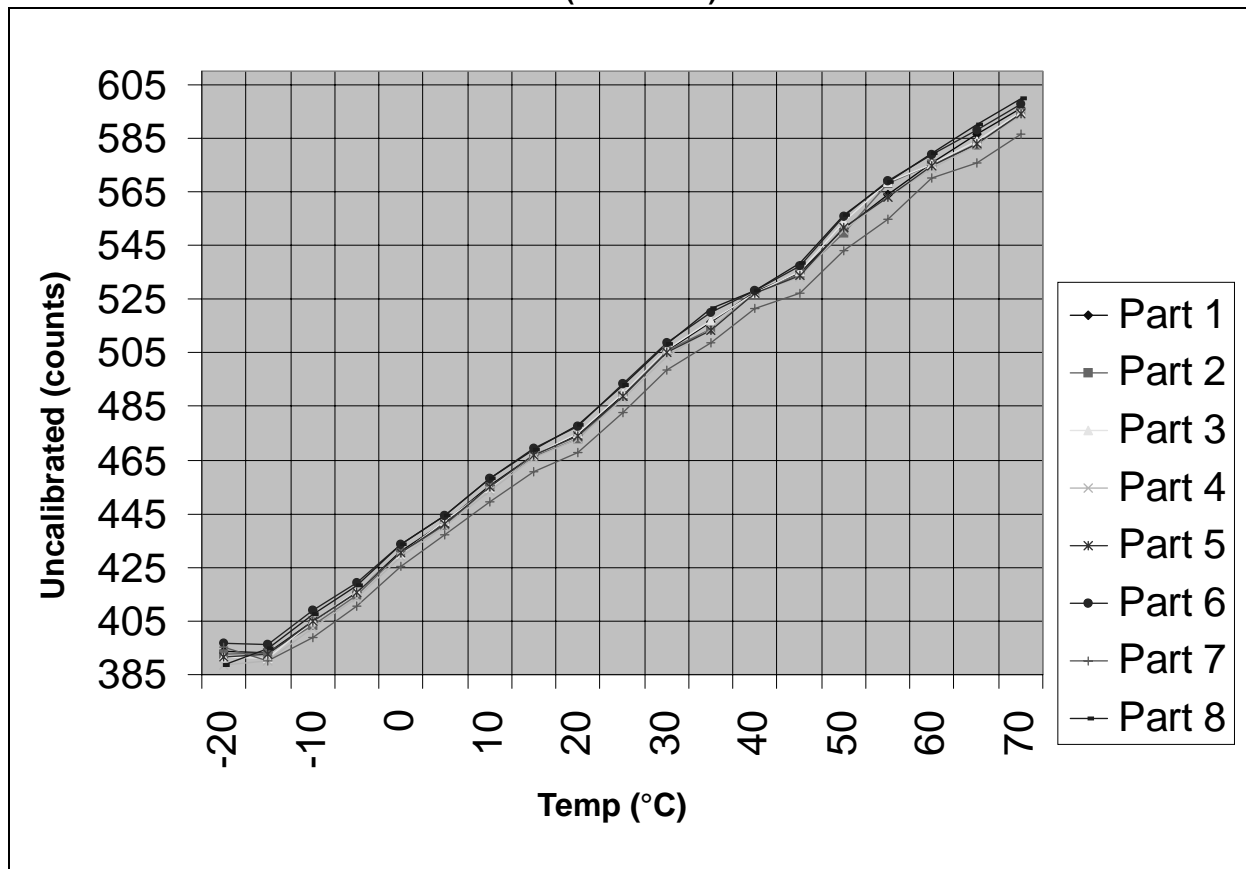


Figure 3 illustrates the standard deviation of the averages listed in Figure 2 across all eight parts under test at each temperature.

FIGURE 3: ACROSS PARTS (V_{DD} = 5.0V)

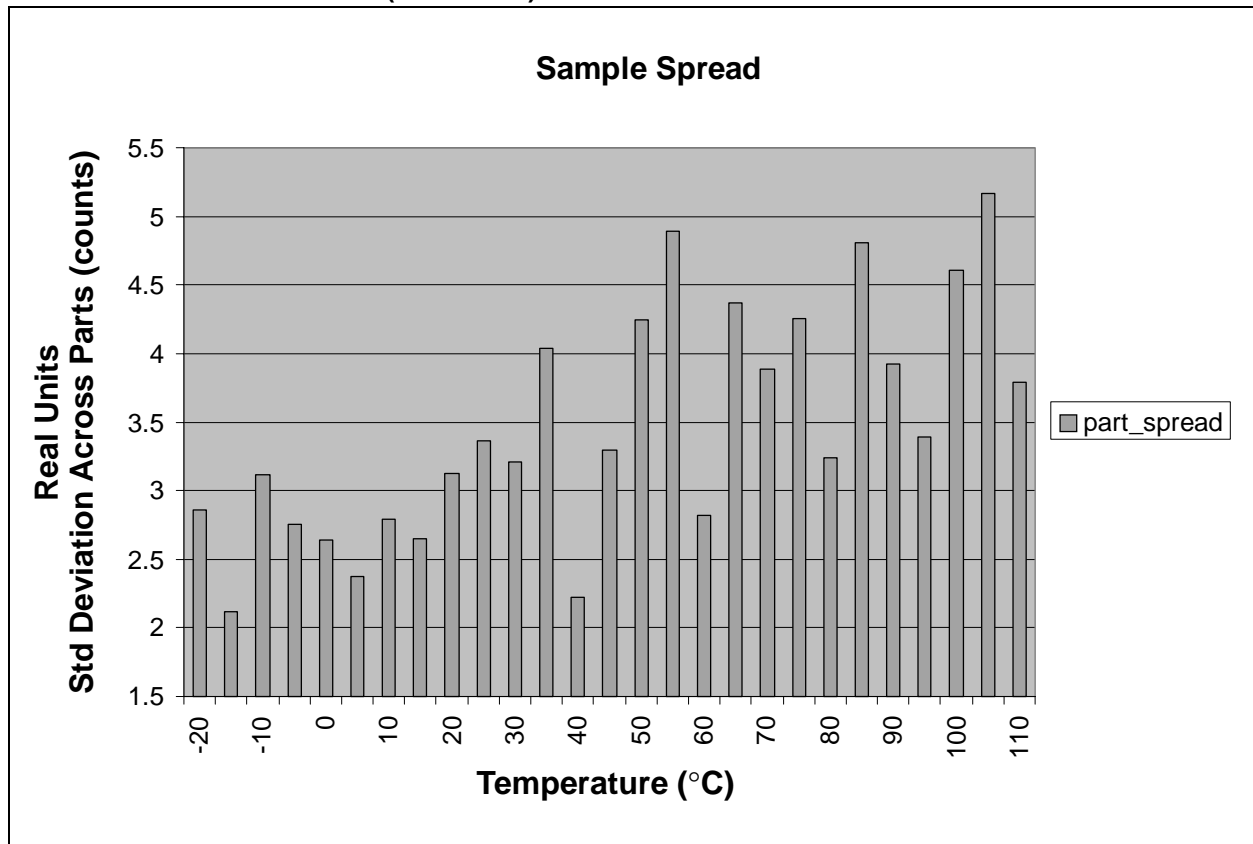


Figure 4 illustrates the standard deviation of the five hundred uncalibrated count data points collected to generate the uncalibrated count averages listed in Figure 2. The three parts with the greatest deviation are listed.

FIGURE 4: ACROSS RAW DATA POINTS ($V_{DD} = 5.0V$)

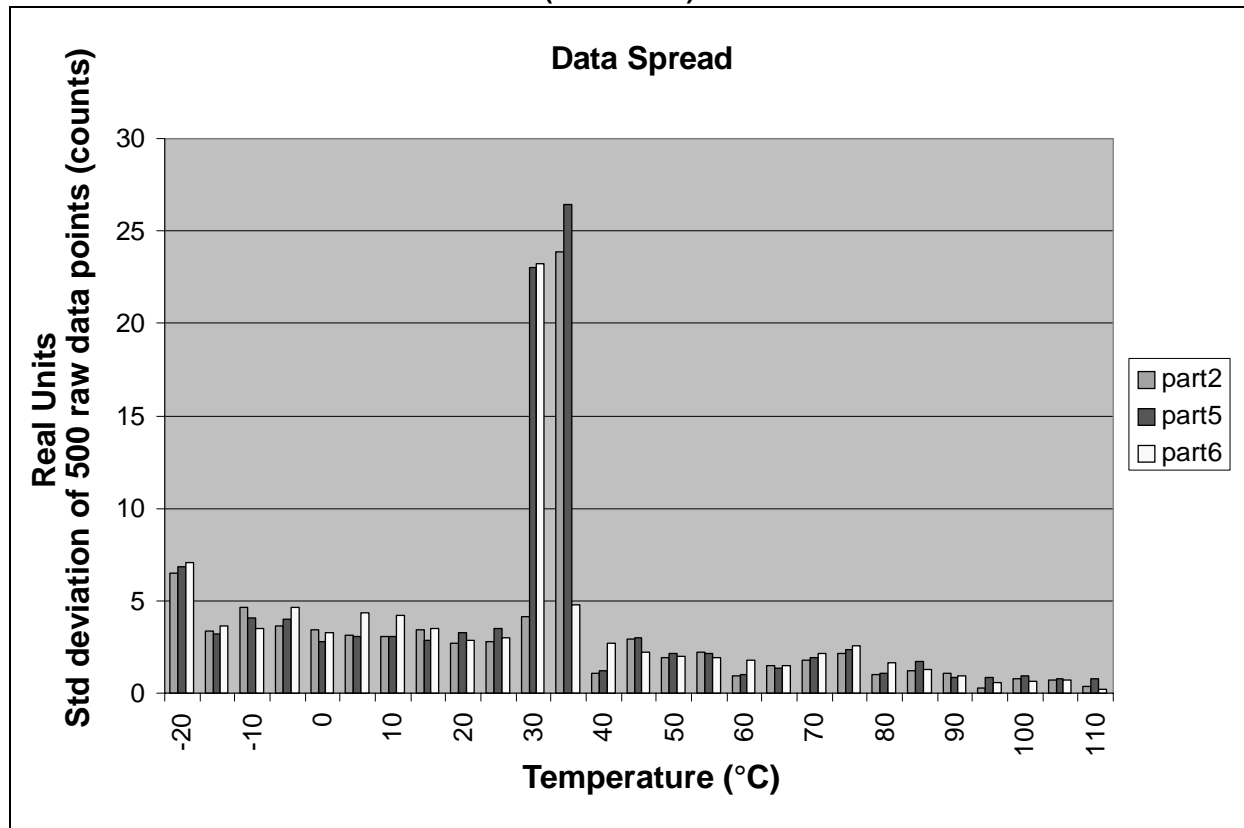
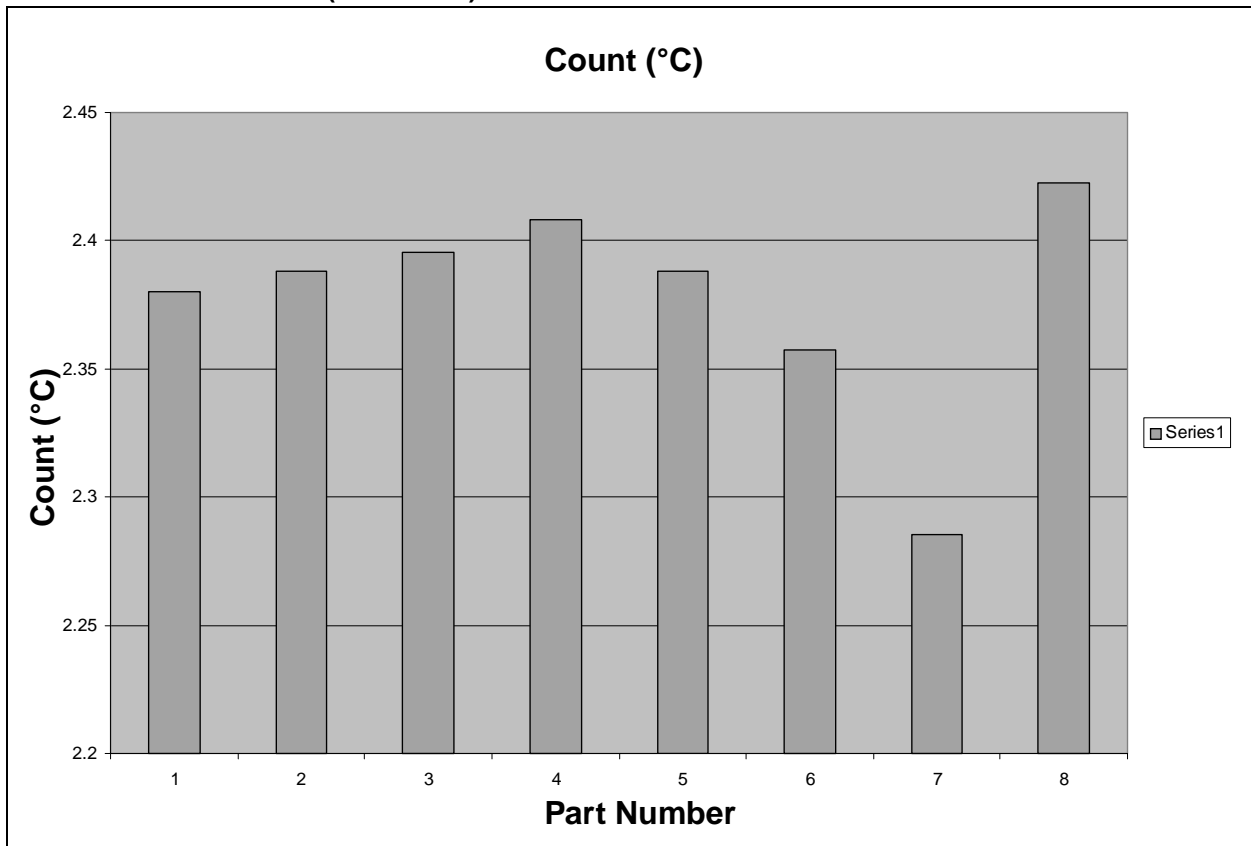


Figure 5 illustrates the calculated uncalibrated COUNTS per degree C for each of the eight tested parts.

FIGURE 5: COUNTS/°C (V_{DD} = 5.0V)



AN720

APPENDIX A: SOURCE CODE

MPASM 02.30 Released

TSTAT2~1.ASM 9-15-1999 13:06:10

PAGE 1

```
LOC OBJECT CODE      LINE SOURCE TEXT
VALUE

00001
;*****
00002 ;This program demonstrates how the WDT and TMR0(reference timer) may be used for
00003 ;rough temperature measurements. No filtering/debounce or algorithm is applied on
00004 ;the raw data. The raw un-calibrated COUNTS are output to a PIC16C54C for transmittal
00005 ;to a PC. GP<1:0> are used for data communication and GP3 is used as an output
;enable.
00006 ;In typical applications, users will need to add code to cover WDT time out when not
00007 ;taking rough temperature measurements. WDT tracking register WDTSTAT bit 0 used to
00008 ;indicate if WDT timeouts are being used for rough temp measurements or in the normal
00009 ;application.
00010 ;
00011 ;
00012 ;      Program:      TSTAT2~1.ASM
00013 ;      Revision Date: 9/7/99 Compatibility with MPLab 4.11
00014 ;
00015 ;
00016 ;
00017
;*****
00018
00019
00020      LIST P=PIC12C509A;, F=INHX8M
00021      #include "P12C509A.INC"
00001      LIST
00002 ; P12C509A.INC Standard Header File, Version 1.00      Microchip Technology, Inc.
00108      LIST
00022
00FF 00FE 00023      __CONFIG _MCLRE_OFF & _CP_OFF & _WDT_ON & _IntrRC_OSC
00024
00025 ;;
00026 ;      declare registers
00027
00028 ;Note *
00029 ;      All core program variables in page 0
00030 ;
00031
00032      cblock      0x07      ;bank 0
00033
00000007 00034 T_COUNT:2      ;counter for # of times tmr0 rolls (lo/hi byte)
00000009 00035 SCREEN      ;screen register for tmr0 roll over
0000000A 00036 DUMP      ;holding register
0000000B 00037 BIT_COUNT      ;# of bits to be sent
0000000C 00038 WDTSTAT      ;status register of wdt being used in
00039      ;temperature or normal application mode
00040
0000000D 00041 TEMP6      ;temp register used by routines
0000000E 00042 TEMP7      ;
0000000F 00043 TEMP8      ;
00044
00045      endc
00046 ;
00047 ;
00048 ;;
00049
0000      00050      org      0x00
```



```

LOC  OBJECT CODE      LINE SOURCE TEXT
VALUE

0000 0025 00051      movwf  OSCCAL          ;load osc calibration for IntrC
0001 0C01 00052      movlw  b'00000001'    ;clear bus driver latch
0002 0026 00053      movwf  GPIO           ;
0003 0CFF 00054      movlw  b'11111111'    ;disable bus drivers
0004 0006 00055      tris   GPIO           ;
0005 04A3 00056      bcf   STATUS,PA0     ;set bank pointers to page 0
0006 04A4 00057      bcf   FSR,5          ;set address map to page 0
0007 04C4 00058      bcf   FSR,6
0008 0A09 00059      goto  Resetvector
00060
00061 ;;
00062 ;      main memory
00063
00064
00065      ;reset vector
0009      00066 Resetvector      ;
00067
0009 0C8B 00068      movlw  b'10001011'    ;load option register word
000A 0002 00069      option      ;
00070
00071      ;check for power on reset
000B 0783 00072      btfs  STATUS,NOT_TO  ;must test condition of TO=1
000C 0A1B 00073      goto  Wdtest         ;to tell if power on reset.
00074      ;there is no sleep mode support.
00075      ;if not a POR, must be a WDT reset.
00076      ;jump to the POR or WDT routines.
00077
00078 ;;
00079      ;power on reset handler
000D      00080 P_reset        ;initialization routine
00081
000D 0C00 00082      movlw  0x00          ;clear counters for measurement
000E 0027 00083      movwf  T_COUNT       ;
000F 0028 00084      movwf  T_COUNT+1     ;
0010 002C 00085      movwf  WDTSTAT       ;clear wdt tracking register
00086
00087
0011 050C 00088      bsf   WDTSTAT,0     ;set tracking register bit 0 to
00089      ;indicate that wdt timeouts are being
00090      ;used for rough temp measurements.
00091      ;This register is typically set elsewhere
00092      ;in a real application but for the
00093      ;purposes of this example, is set here.
00094
00095
00096      ;init timers
0012 0004 00097      clrwdt              ;initialize wdt
0013 0C00 00098      movlw  0x00          ;initialize timer0
0014 0021 00099      movwf  TMR0         ;and allow to free run
00100
0015 0A16 00101      goto  $+1           ;delay to let tmr0 go past
0016 0A17 00102      goto  $+1           ;screen point
0017 0A18 00103      goto  $+1           ;

```

AN720

```
LOC OBJECT CODE      LINE SOURCE TEXT
VALUE
0018 0A19 00104      goto    $+1          ;
0019 0A1A 00105      goto    $+1          ;
00106
001A 0A57 00107      goto    Countimer    ;branch to counting routine
00109 ;;
00110      00110      ;test what type of interrupt
001B      00111 Wdtest
00112      ;test for wdt in temp measure or normal mode
001B 070C 00113      btfss  WDTSTAT,0    ;test wdt mode tracking bit.
00114      ;if =1 then is in temperature mode.
00115      ;if =0 then is in normal app mode.
001C 0A64 00116      goto    Nontempwdt   ;vector to normal app wdt handler here.
00117      ;
00118
00119      ;wdt temperature handler
001D      00120 Wdtvector
00121      ;print raw uncalibrated data
00122
001D      00123 Raw
001D 0C00 00124      movlw  b'00000000'   ;zero communications bus and wait
001E 0026 00125      movwf  GPIO          ;to transfer data
001F 0CFF 00126      movlw  b'11111111'   ;while looking for output enables
0020 0006 00127      tris   GPIO          ;
00128
00129
0021      00130 OE          ;test to see if output is enabled
00131
0021 0004 00132      clrwdt
0022 0206 00133      movf   GPIO,W        ;sample portb
0023 0E08 00134      andlw  b'00001000'   ;mask unwanted bits
0024 002A 00135      movwf  DUMP          ;move to temporary register for test
0025 0C08 00136      movlw  b'00001000'   ;do test
0026 008A 00137      subwf  DUMP,W        ;
0027 0743 00138      btfss  STATUS,Z      ;test carry bit to see if OE.
0028 0A21 00139      goto   OE            ;cannot proceed to send data if no OE
00140      ;
00141
0029      00142 Print       ;setup for xfering data
00143
0029 0C00 00144      movlw  b'00000000'   ;clear data latch
002A 0026 00145      movwf  GPIO          ;
002B 0CFD 00146      movlw  b'11111101'   ;set tris register
002C 0006 00147      tris   GPIO          ;
002D 0C11 00148      movlw  0x11          ;setup bit counter
002E 002B 00149      movwf  BIT_COUNT     ;to send 2 bytes of data
00150      ;
00151
002F      00152 Clock_en    ;once clock setup, check for
00153      ;complete sending of all 2 bytes
00154
002F 02EB 00155      decfsz BIT_COUNT,F   ;test if 16 bits sent
0030 0A32 00156      goto   Senddata     ;
```

```

LOC  OBJECT CODE      LINE SOURCE TEXT
VALUE
0031 0A62 00157      goto   Softreset      ;reinit to take another measurement
      00158              ;
      00159
      00160
0032      00161 Senddata      ;must figure out whether sending upper or
      00162              ;lower byte
      00163
0032 0C09 00164      movlw  0x09            ;test if upper byte or lower byte
0033 008B 00165      subwf  BIT_COUNT,W    ;
0034 0603 00166      btfsc  STATUS,C       ;check to see iv value is zero
0035 0A37 00167      goto   Lower_8        ;jump to send lo byte
0036 0A47 00168      goto   Upper_8        ;jump to send hi byte
      00169              ;
      00170
0037      00171 Lower_8
      00172
0037      00173 Test_lo      ;check for clock strobe from receiving
      00174              ;unit. Clock must be lo. Then go hi.
      00175
0037 0004 00176      clrwdt
0038 0206 00177      movf   GPIO,W         ;test for clock lo to see if ready
0039 002A 00178      movwf  DUMP           ;put in temp register
003A 060A 00179      btfsc  DUMP,0         ;
003B 0A37 00180      goto   Test_lo        ;
      00181              ;
      00182
003C      00183 Test_hi      ;check for clock strobe. Send only on lo to
      00184              ;hi clock transition
      00185
003C 0004 00186      clrwdt
003D 0206 00187      movf   GPIO,W         ;test for clock hi to see if send
003E 002A 00188      movwf  DUMP           ;put in temp register
003F 070A 00189      btfss  DUMP,0         ;
0040 0A3C 00190      goto   Test_hi        ;
      00191              ;
      00192
0041      00193 Lower_8_send  ;xmit data 1 bit at a time by rotating thru
      00194              ;carry and checking it's value
      00195
0041 0426 00196      bcf    GPIO,1         ;reset data line
0042 0327 00197      rrf    T_COUNT,F      ;rotate into carry to test for 1 or 0
0043 0603 00198      btfsc  STATUS,C       ;test for 1 or 0
0044 0526 00199      bsf    GPIO,1         ;clear sending bit
0045 0000 00200      nop
      00201              ;
      00202
      00203
0046 0A2F 00204      goto   Clock_en       ;return to send next data bit
      00205              ;
      00206              ;
      00207
      00208
0047      00209 Upper_8

```

AN720

```
LOC OBJECT CODE      LINE SOURCE TEXT
VALUE
                                00210
                                00211
0047      00212 Test_lo_u      ;check for clock strobe from receiving
                                00213      ;unit. Clock must be lo. Then go hi.
                                00214
0047 0004 00215      clrwdt
0048 0206 00216      movf   GPIO,W      ;test for clock lo to see if ready
0049 002A 00217      movwf  DUMP      ;put in temp register
004A 060A 00218      btfsc DUMP,0      ;
004B 0A47 00219      goto  Test_lo_u   ;
                                00220      ;
                                00221
004C      00222 Test_hi_u      ;check for clock strobe. Send only on lo to
                                00223      ;hi clock transition
                                00224
004C 0004 00225      clrwdt
004D 0206 00226      movf   GPIO,W      ;test for clock hi to see if send
004E 002A 00227      movwf  DUMP      ;put in temp register
004F 070A 00228      btfss DUMP,0      ;
0050 0A4C 00229      goto  Test_hi_u   ;
                                00230      ;
                                00231
0051      00232 Upper_8_send    ;xmit data 1 bit at a time by rotating thru
                                00233      ;carry and checking it's value
                                00234
0051 0426 00235      bcf   GPIO,1      ;reset data line
0052 0328 00236      rrf   T_COUNT+1,F ;rotate into carry to test for 1 or 0
0053 0603 00237      btfsc STATUS,C   ;test for 1 or 0
0054 0526 00238      bsf   GPIO,1      ;clear sending bit
0055 0000 00239      nop
                                00240      ;
                                00241
                                00242
0056 0A2F 00243      goto  Clock_en    ;return to send next data
                                00244      ;
                                00245      ;
                                00246
                                00247
                                00248
                                00249 ;;
                                00250      ;counting routine
0057      00251 Countimer
                                00252
                                00253      ;test to see if timer0 rolls over
0057      00254 Tmr0_byte      ;count the number of tmr0's
                                00255
0057 0201 00256      movf   TMR0,W      ;copy tmr0 value to working register
0058 0029 00257      movwf  SCREEN     ;
0059 0C0A 00258      movlw  0x0A      ;load masking value
005A 0089 00259      subwf  SCREEN,W   ;subtraction to screen for FF -> 0
                                00260      ;transition in tmr0
005B 0603 00261      btfsc  STATUS,C   ;test carry flag for
005C 0A57 00262      goto  Tmr0_byte   ;loop back and test for FF -> 0
```

```
LOC OBJECT CODE      LINE SOURCE TEXT
VALUE
                                00263
                                00264      ;increment count lo byte
005D 02A7 00265      incf    T_COUNT,F          ;incr count (lo byte) once for every
                                00266      ;tmr0 roll over
005E 0743 00267      btfs   STATUS,Z          ;test zero flag to see if need to
                                00268      ;increment hi byte of count (16 bit
counter)
005F 0A57 00269      goto   Tmr0_byte         ;loop back and test until wdt reset
                                00270
                                00271      ;increment count hi byte
0060 02A8 00272      incf   T_COUNT+1,F       ;incr count (hi byte) once for every
                                00273      ;T_COUNT roll over
0061 0A57 00274      goto   Tmr0_byte         ;loop back and test until wdt reset
                                00275
                                00276
                                00277 ;;
                                00278      ;soft reset routine
0062      00279 Softreset          ;clear conditions and reset for another
                                00280      ;rough temperature measurement
                                00281
0062 0004 00282      clrwdt                    ;clear the wdt
0063 0A0D 00283      goto   P_reset           ;return to reset checks
                                00284
                                00285
                                00286 ;;
                                00287      ;non-temp measurement mode wdt handler
0064      00288 Nontempwdt
0064 0A64 00289      goto   $                 ;normal mode wdt timeout handler.
                                00290      ;since only running in rough temp measure
                                00291      ;mode, routine is just a place holder.
                                00292
                                00293
                                00294 ;;
                                00295      end
```

AN720

SYMBOL TABLE

LABEL	VALUE
BIT_COUNT	0000000B
C	00000000
Clock_en	0000002F
Countimer	00000057
DC	00000001
DUMP	0000000A
F	00000001
FSR	00000004
GPIO	00000006
GPWUF	00000007
INDF	00000000
Lower_8	00000037
Lower_8_send	00000041
NOT_GPPU	00000006
NOT_GPWU	00000007
NOT_PD	00000003
NOT_TO	00000004
Nontempwdt	00000064
OE	00000021
OSCCAL	00000005
OSCFST	00000003
OSCSLW	00000002
PA0	00000005
PCL	00000002
PS0	00000000
PS1	00000001
PS2	00000002
PSA	00000003
P_reset	0000000D
Print	00000029
Raw	0000001D
Resetvector	00000009
SCREEN	00000009
STATUS	00000003
Senddata	00000032
Softreset	00000062
T0CS	00000005
T0SE	00000004
TEMP6	0000000D
TEMP7	0000000E
TEMP8	0000000F
TMR0	00000001
T_COUNT	00000007
Test_hi	0000003C
Test_hi_u	0000004C
Test_lo	00000037
Test_lo_u	00000047
Tmr0_byte	00000057
Upper_8	00000047
Upper_8_send	00000051
W	00000000
WDTSTAT	0000000C
Wdtest	0000001B

SYMBOL TABLE

LABEL	VALUE
Wdtvector	0000001D
Z	00000002
_CP_OFF	00000FFF
_CP_ON	00000FF7
_ExtRC_OSC	00000FFF
_IntrC_OSC	00000FFE
_LP_OSC	00000FFC
_MCLRE_OFF	00000FEF
_MCLRE_ON	00000FFF
_WDT_OFF	00000FFB
_WDT_ON	00000FFF
_XT_OSC	00000FFD
__12C509A	00000001

MEMORY USAGE MAP ('X' = Used, '-' = Unused)

```

0000 : XXXXXXXXXXXXXXXXXXXX XXXXXXXXXXXXXXXXXXXX XXXXXXXXXXXXXXXXXXXX XXXXXXXXXXXXXXXXXXXX
0040 : XXXXXXXXXXXXXXXXXXXX XXXXXXXXXXXXXXXXXXXX XXXXX-----
0FC0 : -----X
    
```

All other memory blocks unused.

```

Program Memory Words Used: 101
Program Memory Words Free: 923
    
```

```

Errors : 0
Warnings : 0 reported, 0 suppressed
Messages : 0 reported, 0 suppressed
    
```



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

Microchip Technology Inc.
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-786-7200 Fax: 480-786-7277
Technical Support: 480-786-7627
Web Address: <http://www.microchip.com>

Atlanta

Microchip Technology Inc.
500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770-640-0034 Fax: 770-640-0307

Boston

Microchip Technology Inc.
5 Mount Royal Avenue
Marlborough, MA 01752
Tel: 508-480-9990 Fax: 508-480-8575

Chicago

Microchip Technology Inc.
333 Pierce Road, Suite 180
Itasca, IL 60143
Tel: 630-285-0071 Fax: 630-285-0075

Dallas

Microchip Technology Inc.
4570 Westgrove Drive, Suite 160
Addison, TX 75248
Tel: 972-818-7423 Fax: 972-818-2924

Dayton

Microchip Technology Inc.
Two Prestige Place, Suite 150
Miamisburg, OH 45342
Tel: 937-291-1654 Fax: 937-291-9175

Detroit

Microchip Technology Inc.
Tri-Atria Office Building
32255 Northwestern Highway, Suite 190
Farmington Hills, MI 48334
Tel: 248-538-2250 Fax: 248-538-2260

Los Angeles

Microchip Technology Inc.
18201 Von Karman, Suite 1090
Irvine, CA 92612
Tel: 949-263-1888 Fax: 949-263-1338

New York

Microchip Technology Inc.
150 Motor Parkway, Suite 202
Hauppauge, NY 11788
Tel: 631-273-5305 Fax: 631-273-5335

San Jose

Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408-436-7950 Fax: 408-436-7955

AMERICAS (continued)

Toronto

Microchip Technology Inc.
5925 Airport Road, Suite 200
Mississauga, Ontario L4V 1W1, Canada
Tel: 905-405-6279 Fax: 905-405-6253

ASIA/PACIFIC

Hong Kong

Microchip Asia Pacific
Unit 2101, Tower 2
Metroplaza
223 Hing Fong Road
Kwai Fong, N.T., Hong Kong
Tel: 852-2-401-1200 Fax: 852-2-401-3431

Beijing

Microchip Technology, Beijing
Unit 915, 6 Chaoyangmen Bei Dajie
Dong Erhuan Road, Dongcheng District
New China Hong Kong Manhattan Building
Beijing 100027 PRC
Tel: 86-10-85282100 Fax: 86-10-85282104

India

Microchip Technology Inc.
India Liaison Office
No. 6, Legacy, Convent Road
Bangalore 560 025, India
Tel: 91-80-229-0061 Fax: 91-80-229-0062

Japan

Microchip Technology Intl. Inc.
Benex S-1 6F
3-18-20, Shinyokohama
Kohoku-Ku, Yokohama-shi
Kanagawa 222-0033 Japan
Tel: 81-45-471-6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku
Seoul, Korea
Tel: 82-2-554-7200 Fax: 82-2-558-5934

Shanghai

Microchip Technology
RM 406 Shanghai Golden Bridge Bldg.
2077 Yan'an Road West, Hong Qiao District
Shanghai, PRC 200335
Tel: 86-21-6275-5700 Fax: 86 21-6275-5060

ASIA/PACIFIC (continued)

Singapore

Microchip Technology Singapore Pte Ltd.
200 Middle Road
#07-02 Prime Centre
Singapore 188980
Tel: 65-334-8870 Fax: 65-334-8850

Taiwan, R.O.C

Microchip Technology Taiwan
10F-1C 207
Tung Hua North Road
Taipei, Taiwan, ROC
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

United Kingdom

Arizona Microchip Technology Ltd.
505 Eskdale Road
Wokingham
Berkshire, England RG41 5TU
Tel: 44 118 921 5858 Fax: 44-118 921-5835

Denmark

Microchip Technology Denmark ApS
Regus Business Centre
Lautrup hof 1-3
Ballerup DK-2750 Denmark
Tel: 45 4420 9895 Fax: 45 4420 9910

France

Arizona Microchip Technology SARL
Parc d'Activite du Moulin de Massy
43 Rue du Saule Trapu
Batiment A - 1er Etage
91300 Massy, France
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Arizona Microchip Technology GmbH
Gustav-Heinemann-Ring 125
D-81739 München, Germany
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Italy

Arizona Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Taurus 1 V. Le Colleoni 1
20041 Agrate Brianza
Milan, Italy
Tel: 39-039-65791-1 Fax: 39-039-6899883

11/15/99



Microchip received QS-9000 quality system certification for its worldwide headquarters, design and water fabrication facilities in Chandler and Tempe, Arizona in July 1999. The Company's quality system processes and procedures are QS-9000 compliant for its PICmicro® 8-bit MCUs, KEELOC® code hopping devices, Serial EEPROMs and microperipheral products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001 certified.

All rights reserved. © 1999 Microchip Technology Incorporated. Printed in the USA. 11/99 Printed on recycled paper.

Information contained in this publication regarding device applications and the like is intended for suggestion only and may be superseded by updates. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights. The Microchip logo and name are registered trademarks of Microchip Technology Inc. in the U.S.A. and other countries. All rights reserved. All other trademarks mentioned herein are the property of their respective companies.